SPECIFICATION

产品规格书

NO.(编号）：　　RD Version

Part No.(型号）：　　5050A06-XXS75-U2S6P-V1-T-LX

Description(描述）：　　5050 White LED

Model(说明）：　　EMC5050 6V CRI90

CUSTOMER APPEROVED (客户审核）	APPROVED （核准）	ISSUED （制定）
	朱磊	王磊

SHINEON (NANCHANG) TECHNOLOGY CO.,LTD

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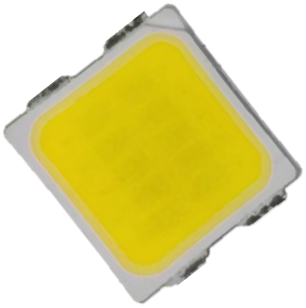
TEL: 0791-88130119
http://www.shineon.cn

5050A06-XXS75-U2S6P-V1-T-LX Datasheet

This 5050 LED Light Source is a high performance energy efficient device which can handle high thermal and high driving current. The small package outline and high intensity make it an ideal choice for LED panel light, LED bulb light, LED tube light, backlighting and etc.



The White Power LED is available in the range of color temperature from 2700K to 6500K.

This part has a foot print that is compatible to most of the same size LED in the market today.

FEATURES

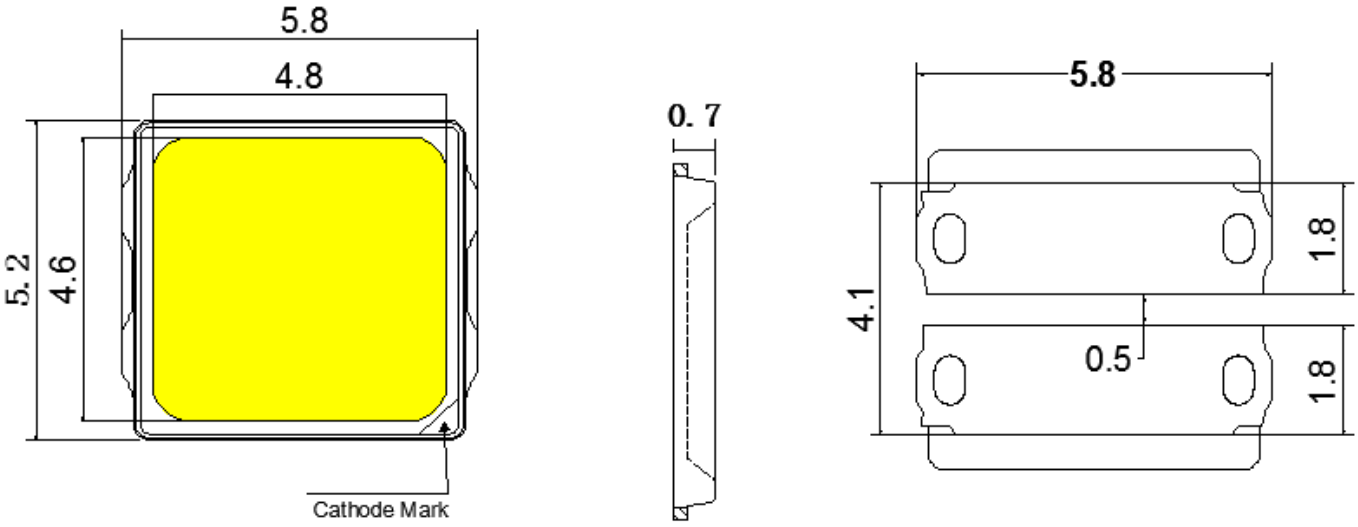
- Available in Cool White, Neutral White and Warm White color
- ANSI-compatible chromaticity bins
- High luminous Intensity and high efficiency
- Compatible with reflow soldering process
- Low thermal resistance
- Long operation life
- Wide viewing angle at 120°
- Silicone encapsulation
- EMC package
- Environmental friendly, RoHS compliance

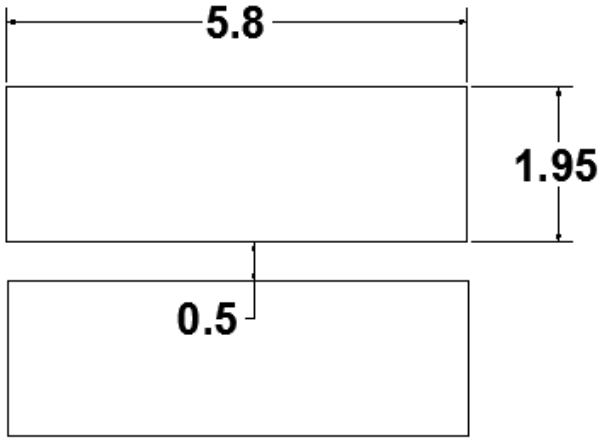
APPLICATIONS

- Street lighting
- Par lighting
- Outdoor lighting

Note: The information in this document is subject to change without notice.

PACKAGE DIMENSIONS





Recommended PCB Soldering Pad Pattern

Notes:
1. All dimensions in millimeters.
2. Thickness tolerance of copper plate is ±0.02mm.
3. Thickness tolerance of product is ±0.05mm.
4. Tolerance is ±0.1mm unless otherwise noted.

ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Absolute Maximum Rating	Unit
Forward current	I_F	1000	mA
Peak Forward Current[1]	I_{FP}	1500	mA
Reverse Voltage	V_R	10	V
Power Dissipation	Pd	6700	mW
Operating solder pointTemperature	T_{SP}	-40~+105	℃
Storage Temperature	T_{stg}	-40~+105	℃
Soldering Temperature	T_{sld}	Reflow Soldering: 260℃ for 10 seconds	
LED Junction Temperature	T_j	125	℃
ESD Sensitivity (HBM)	--	2000	V

Note:
I_{FP} Conditions: Pulse Width≦10msec. and Duty ≦1/10.

CHARACTERISTICS (Tj=25℃)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage[1]	V_F	IF=750mA	5.8	--	6.2	V
Viewing Angle	$2\theta_{1/2}$	IF=750mA	--	120	--	deg.
Luminous Flux	Φv	IF=750mA	630	--	760	lm
Color Rendering Index	CRI	IF=750mA	90	--	--	--
Color Temperature	CCT	IF=750mA	2700	--	6500	K
Thermal Resistance (Junction to Solder Point)	R_{th-js}	IF=750mA	--	2.0	--	℃/W

Notes:
1. Luminous flux is measured with an accuracy of ± 10%.
2. Chromaticity coordinate bins are measured with an accuracy of ± 0.01.
3. CRI is measured with an accuracy of ± 2 ;
4. Some color and CRI bins may have limited availability, please contact us before ordering.
5. All measurements were made under the standardized environment of Shineon

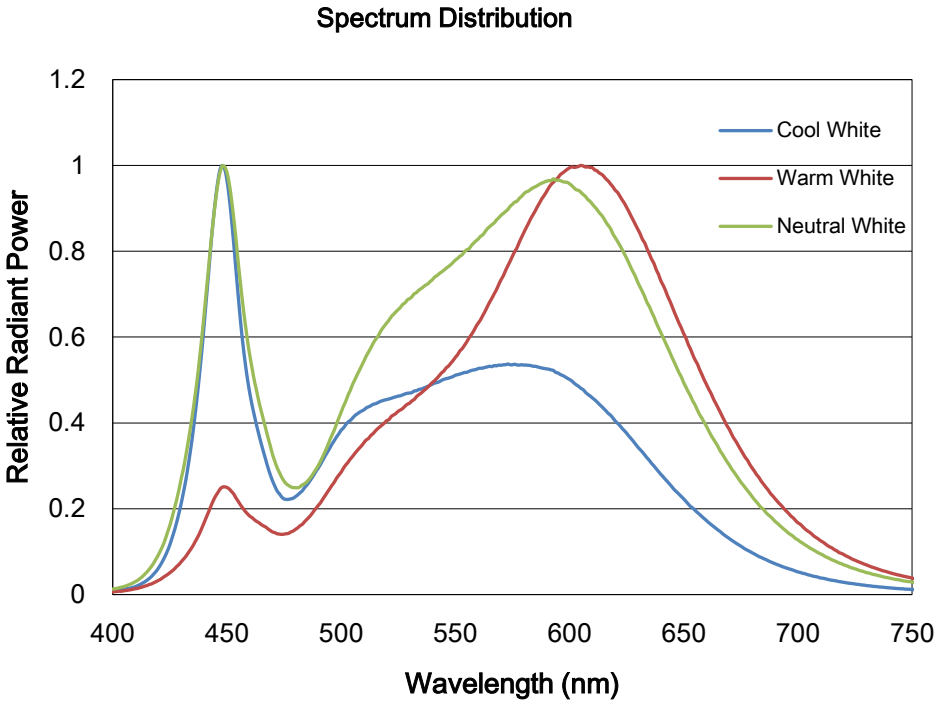
ELECTRO-OPTICAL CHARACTERISTICS 光电参数

(Tj=25℃; CRI90 ; 4000K)

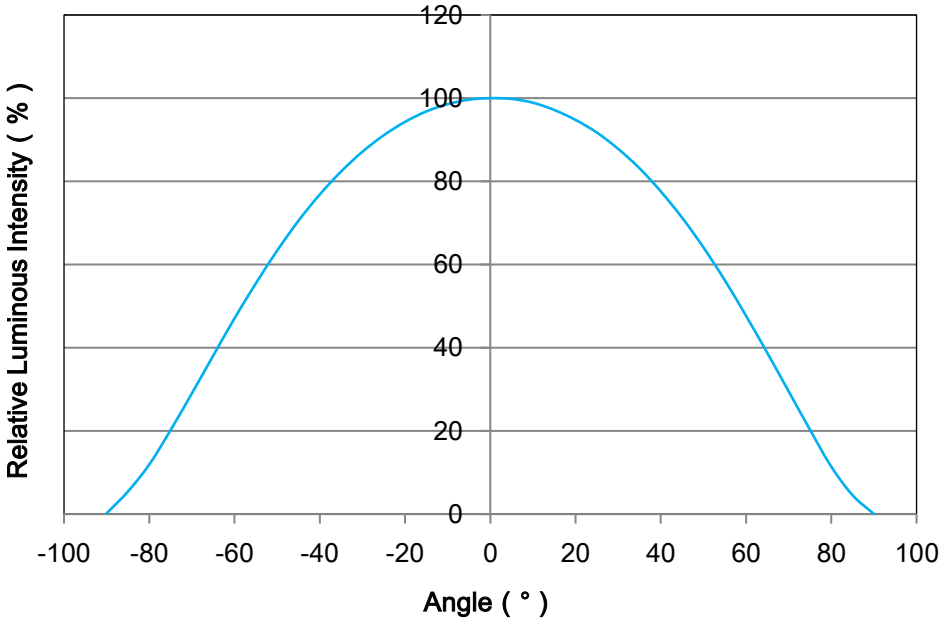
Forward Current	Forward Voltage	Power	Luminous Flux	Luminous efficacy
	Typ	Typ	Typ	Typ
IF	VF	P	ΦV	η
100 mA	5.26 V	0.52 W	105 lm	198 lm/W
200 mA	5.41 V	1.08 W	210 lm	192 lm/W
300 mA	5.54V	1.66 W	307 lm	186 lm/W
400 mA	5.66 V	2.26 W	409 lm	180 lm/W
500 mA	5.77 V	2.88 W	503 lm	175 lm/W
600 mA	5.88 V	3.53 W	599 lm	169 lm/W
700 mA	5.93 V	4.19 W	691 lm	165 lm/W
800 mA	5.99 V	4.87 W	780 lm	160 lm/W
900 mA	6.09 V	5.57 W	869 lm	156 lm/W
1000 mA	6.19 V	6.30 W	954 lm	152 lm/W

Notes:
1. Luminous flux is measured with an accuracy of ± 10%.
2. Chromaticity coordinate bins are measured with an accuracy of ± 0.01.
3. CRI is measured with an accuracy of ± 2 ;
4. Some color and CRI bins may have limited availability, please contact us before ordering.
5. All measurements were made under the standardized environment of Shineon

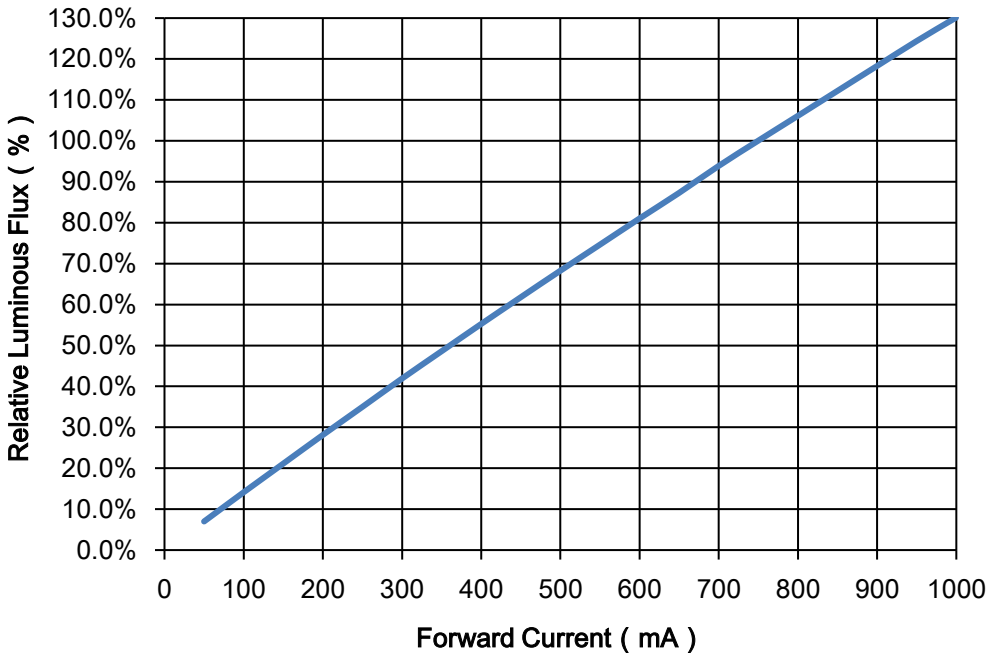
RELATIVE SPECTRAL POWER DISTRIBUTION (T_j=25℃)



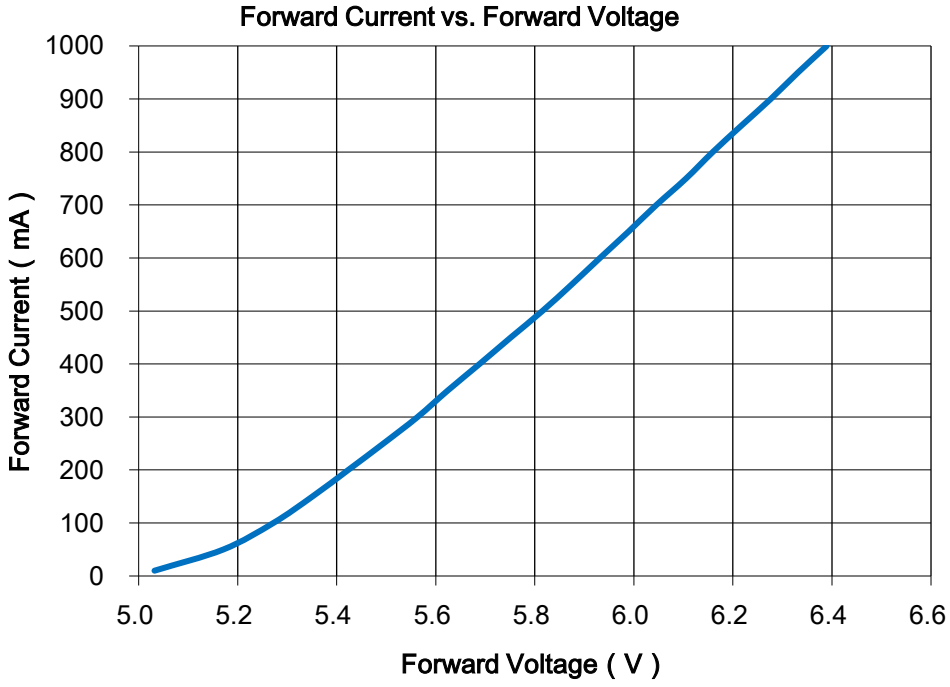
TYPICAL SPATIAL DISTRIBUTION



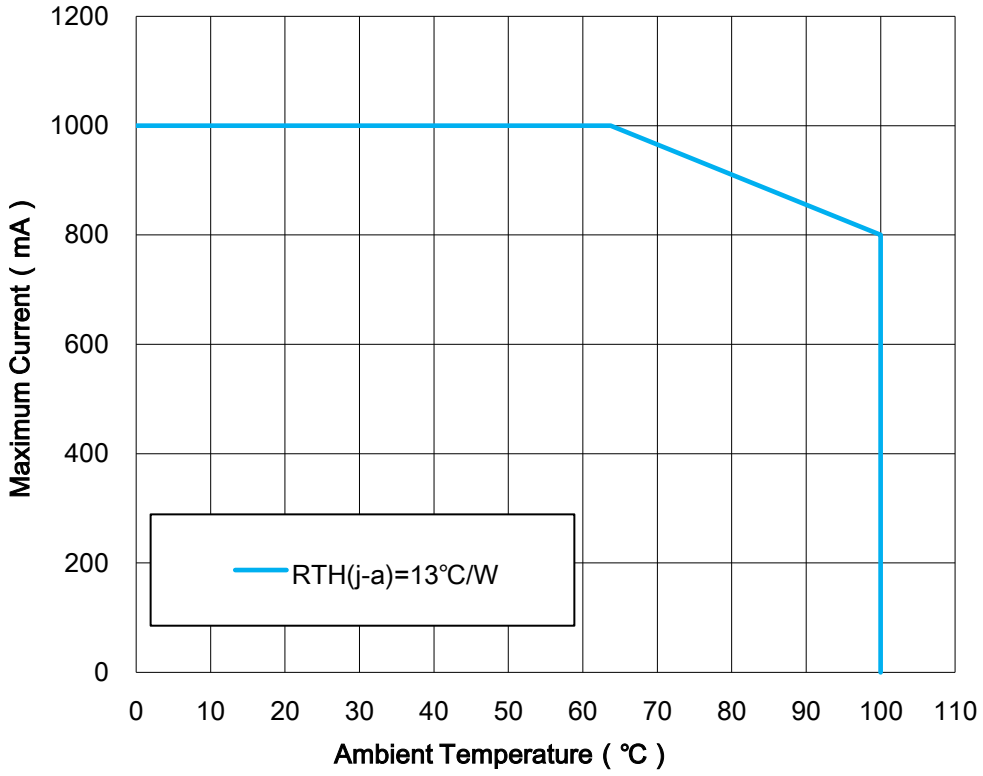
RELATIVE LUMINOUS FLUX VS. CURRENT (T_j=25℃)



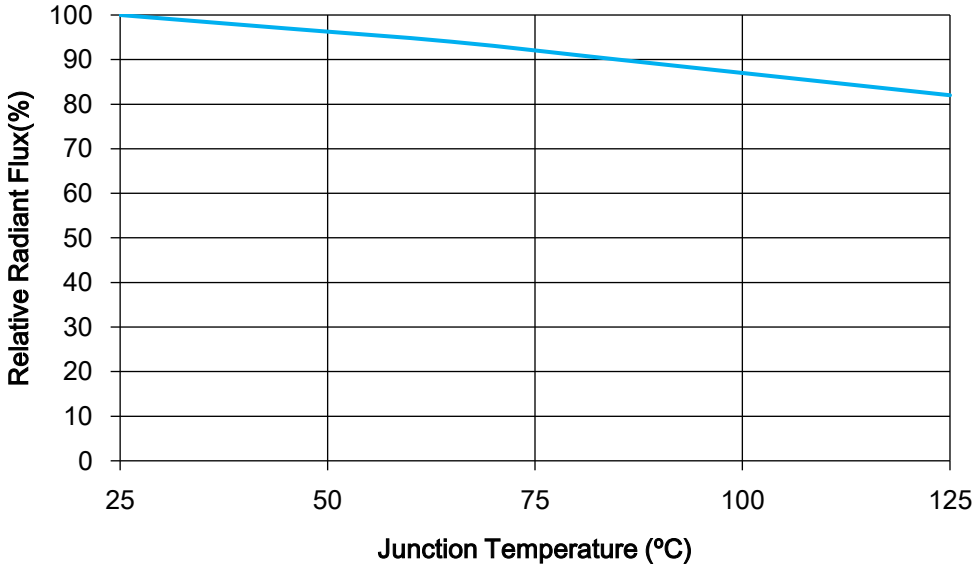
ELECTRICAL CHARACTERISTICS (Tj=25℃)



MAXIUM CURRENT VS. AMBIENT TEMPERATURE



RELATIVE RADIANT FLUX VS. JUNCTION TEMPERATURE



SORTING RANKS

(1) Luminous Flux (Tj=25℃)

Part Number	Condition	Rank	Unit
5050A06-27S75-U2S6P-V1-T-LX	750mA	V6	lm
		630-680	
5050A06-30S75-U2S6P-V1-T-LX		V30	
		660-710	
5050A06-35S75-U2S6P-V1-T-LX		V4	
		690-740	
5050A06-40S75-U2S6P-V1-T-LX		W1	
		710-760	
5050A06-50S75-U2S6P-V1-T-LX		W1	
		710-760	
5050A06-57S75-U2S6P-V1-T-LX		W1	
		710-760	
5050A06-60S75-U2S6P-V1-T-LX		W0	
		700-750	
5050A06-65S75-U2S6P-V1-T-LX		W0	
		700-750	

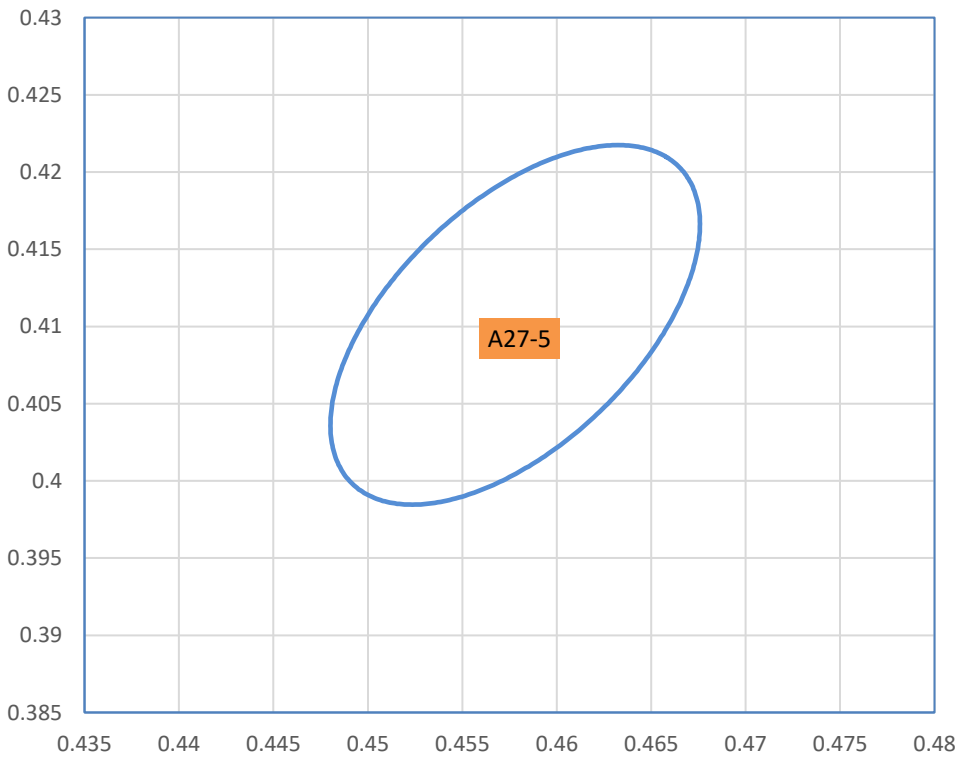
(2) Forward Voltage (Tj=25℃)

Rank	Condition	Min.	Max.	Unit
C9	750mA	5.8	6.0	V
D0		6.0	6.2	

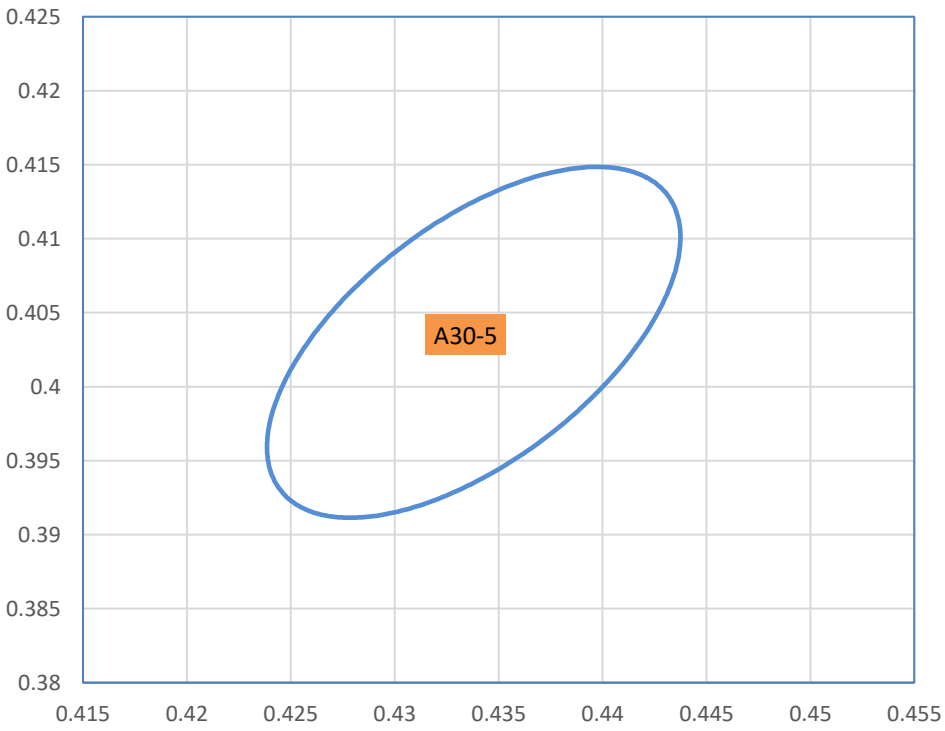
Notes:
1. 10% tolerance for luminous intensity may be caused by measurement inaccuracy.
2. Measurement Uncertainty of the Forward Voltage : ± 0.06V

(3) Chromaticity Bins 色坐标等级

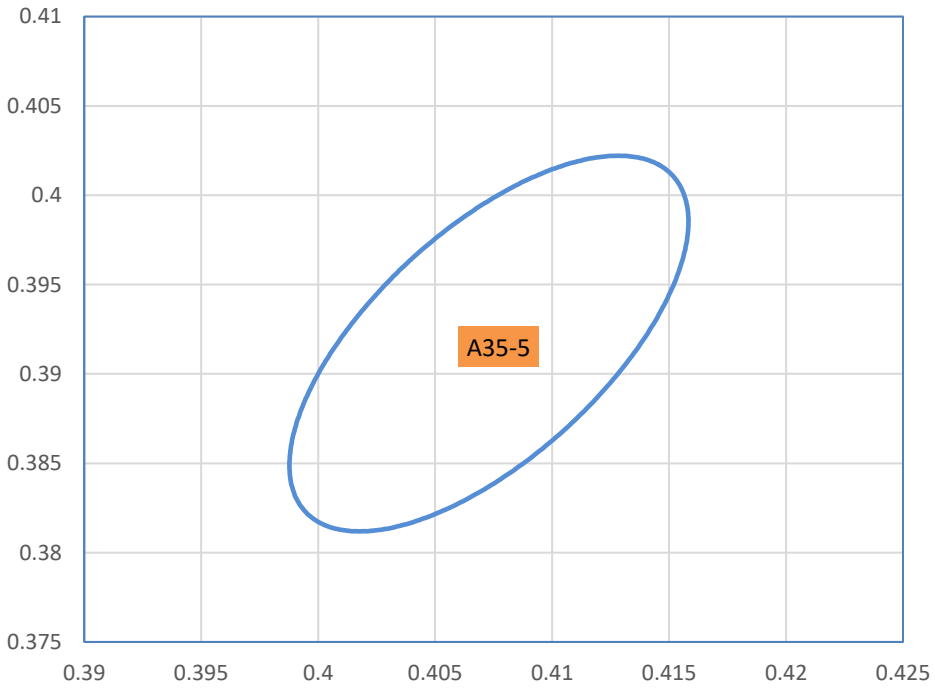
Part Number 品名	5050A06-27S75-U2S2P-V1-T-LX			CCT 色温	2700K
Bin Code 等级代码	Color Coordinates 色坐标(x,y)				
A27-5	x	y	a	b	Theta°
	0.4578	0.4101	0.01290	0.00685	53.17



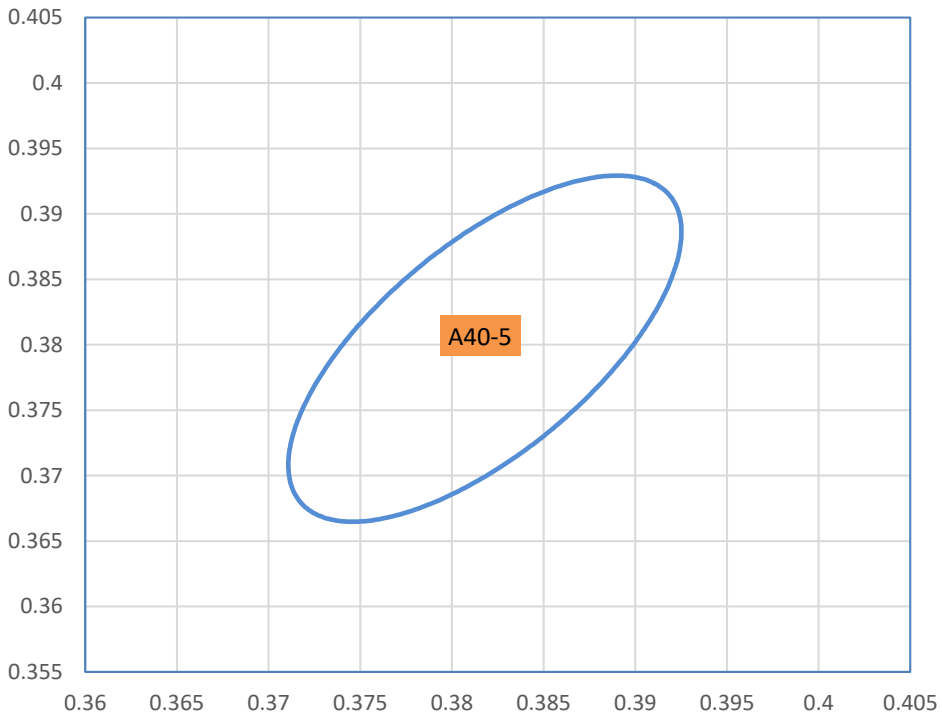
Part Number 品名	5050A06-30S75-U2S2P-V1-T-LX			CCT 色温	3000K
Bin Code 等级代码	Color Coordinates 色坐标(x,y)				
A30-5	x	y	a	b	Theta°
	0.4338	0.403	0.01390	0.00680	53.2167



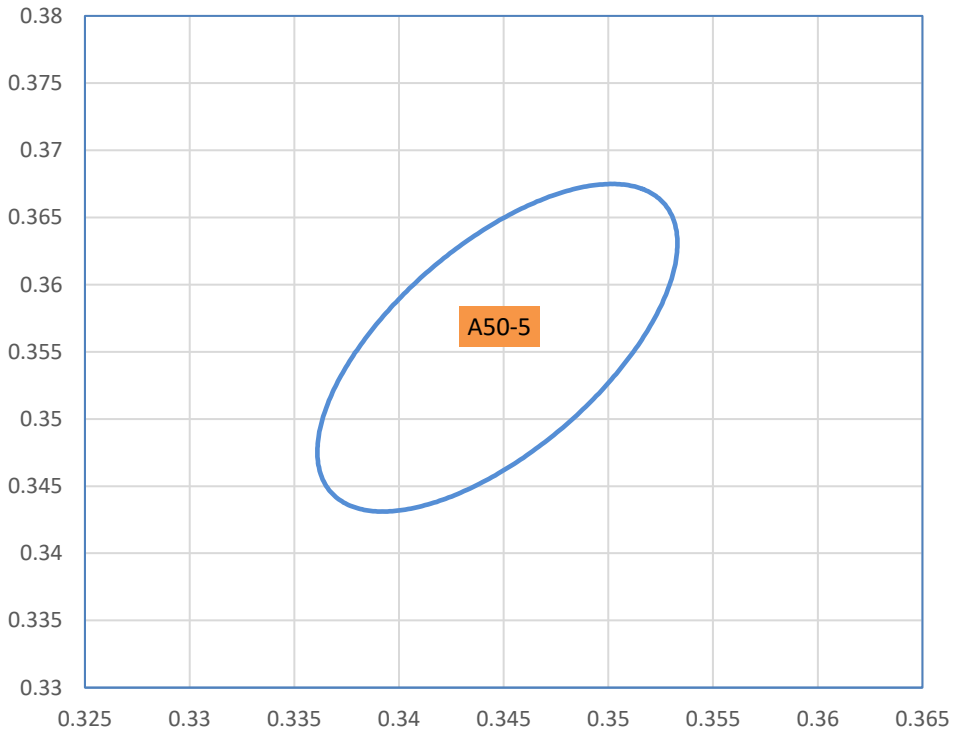
Part Number 品名	5050A06-35S75-U2S2P-V1-T-LX			CCT 色温	3500K
Bin Code 等级代码	Color Coordinates 色坐标(x,y)				
A35-5	x	y	a	b	Theta°
	0.4073	0.3917	0.01545	0.0069	54



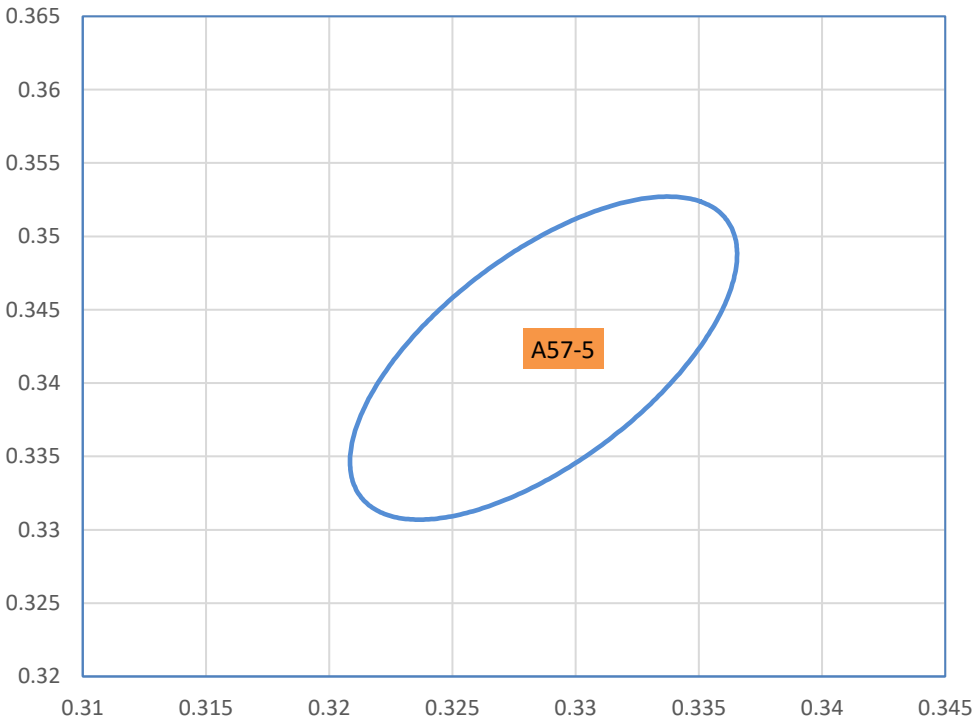
Part Number 品名	5050A06-40S75-U2S2P-V1-T-LX			CCT 色温	4000K
Bin Code 等级代码	Color Coordinates 色坐标(x,y)				
A40-5	x	y	a	b	Theta°
	0.3818	0.3797	0.01565	0.00670	53.717



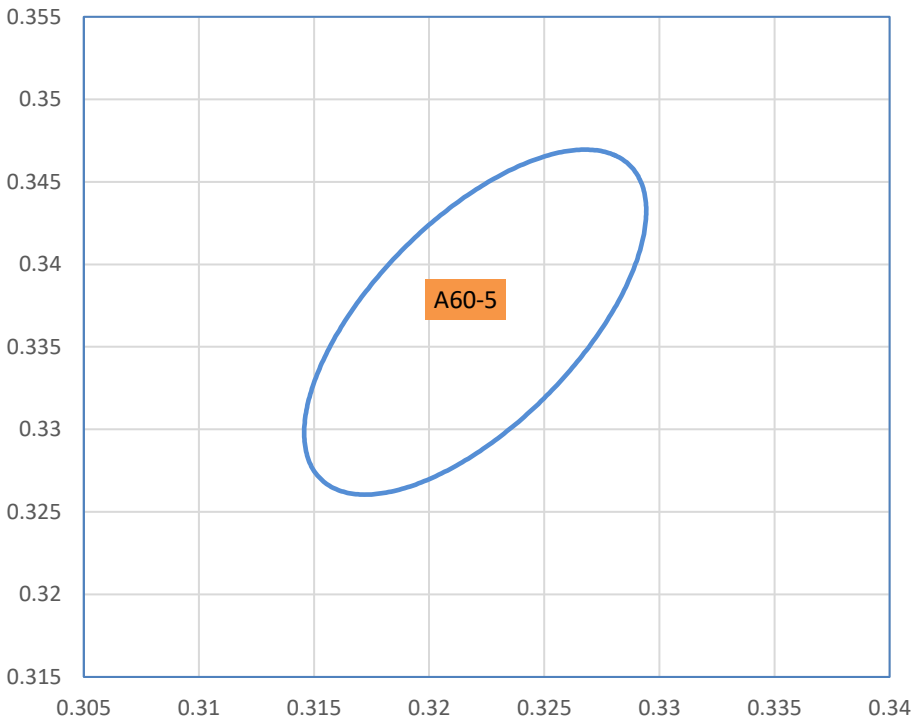
Part Number 品名	5050A06-50S75-U2S2P-V1-T-LX			CCT 色温	5000K
Bin Code 等级代码	Color Coordinates 色坐标(x,y)				
A50-5	x	y	a	b	Theta°
	0.3447	0.3553	0.01370	0.00590	59.617



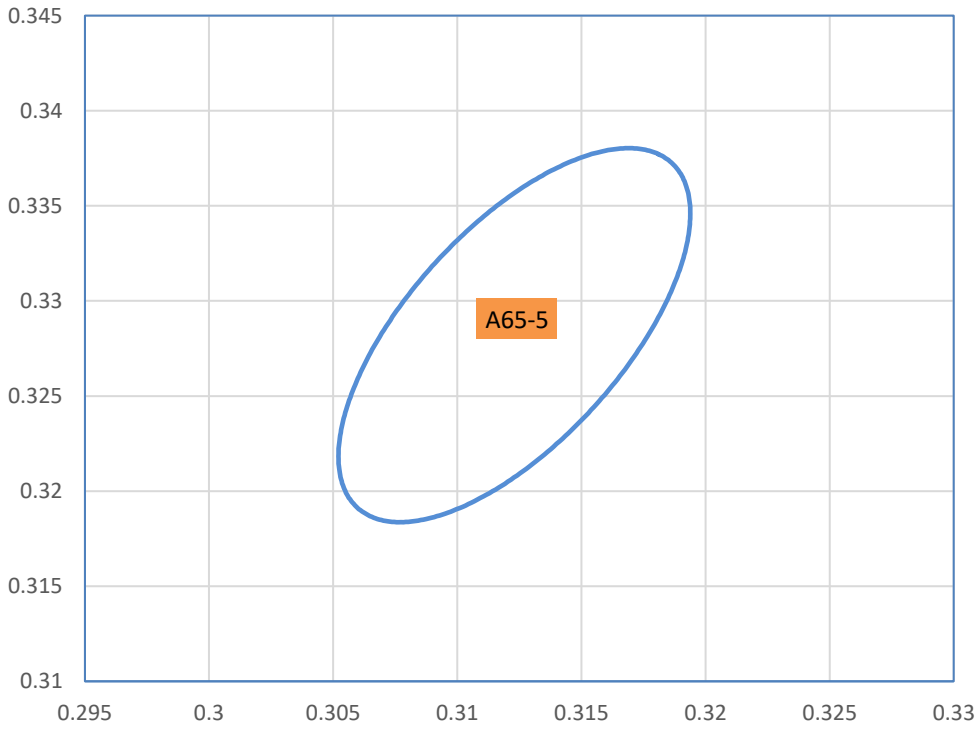
Part Number 品名	5050A06-57S75-U2S2P-V1-T-LX			CCT 色温	5700K
Bin Code 等级代码	Color Coordinates 色坐标(x,y)				
A57-5	x	y	a	b	Theta°
	0.3287	0.3417	0.01245	0.00535	59.128



Part Number 品名	5050A06-60S75-U2S2P-V1-T-LX			CCT 色温	6000K
Bin Code 等级代码	Color Coordinates 色坐标(x,y)				
A60-5	x	y	a	b	Theta°
	0.322	0.3365	0.01179	0.00504	59.21



Part Number 品名	5050A06-65S75-U2S2P-V1-T-LX			CCT 色温	6500K
Bin Code 等级代码	Color Coordinates 色坐标(x,y)				
A65-5	x	y	a	b	Theta°
	0.3123	0.3282	0.01115	0.00475	58.5667

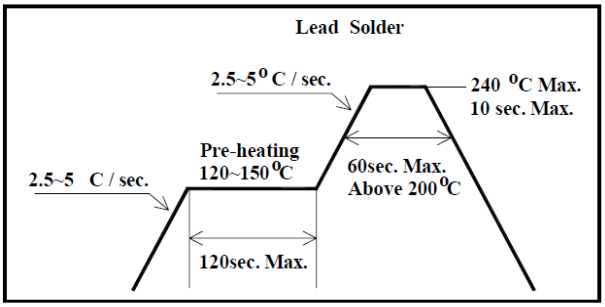


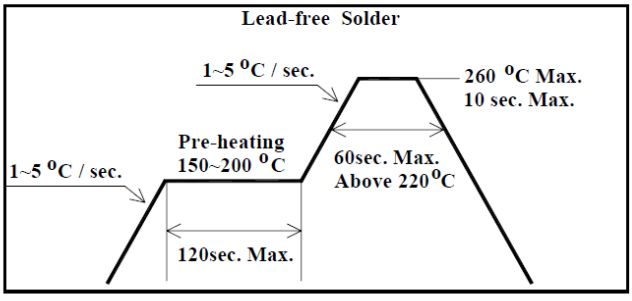
REFLOW SOLDERING CHARACTERISTICS

For Reflow Process:

Preheating : 140℃~160℃±5℃,within 2 minutes.
Operation heating : 260℃(Max.) within 10 seconds.(Max)
Gradual Cooling (Avoid quenching).

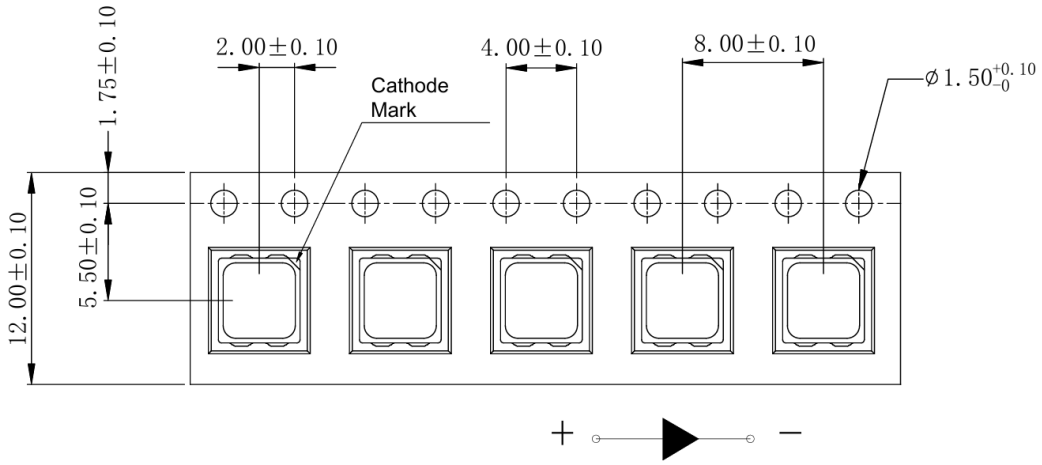
Lead solder		Lead-free solder	
Pre-heat	120-150℃	Pre-heat	150-200℃
Pre-heat time	120 sec.Max.	Pre-heat time	120 sec.Max.
Peak Temperature	240℃ Max.	Peak Temperature	260℃ Max.
Soldering time condition	10 sec.Max.	Soldering time condition	10 sec.Max.



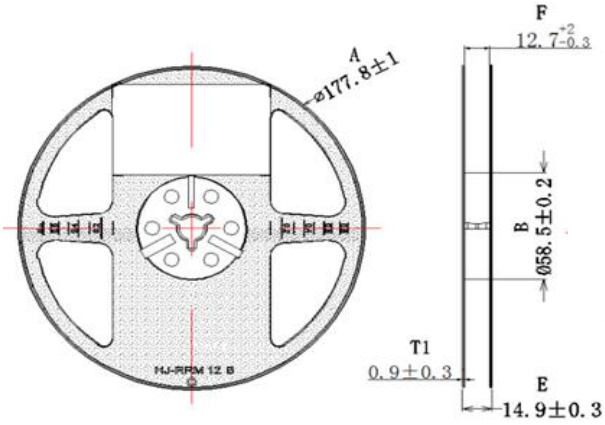


Notes:
The encapsulated material of the LEDs is silicone . Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will be influence to the reliability of the LEDs. Precautions should be taken to avoid the strong pressure on the encapsulated part. So when using the picking up nozzle, the pressure on the silicone resin should be proper.

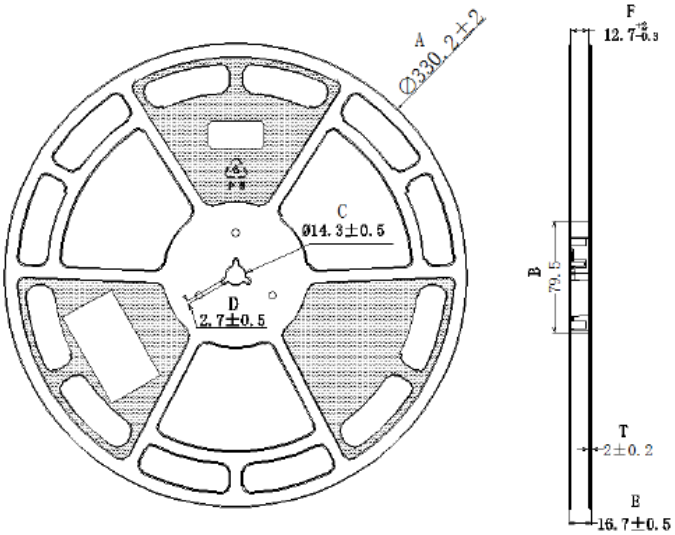
TAPE AND REEL



Small reel



Big reel



Notes:

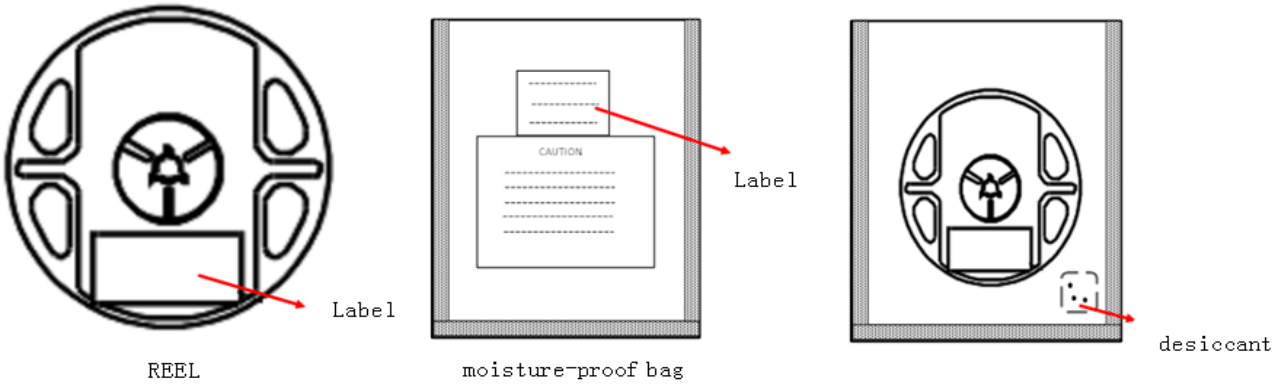
(1) Quantity : 1500pcs/Reel OR 5,000pcs/Reel

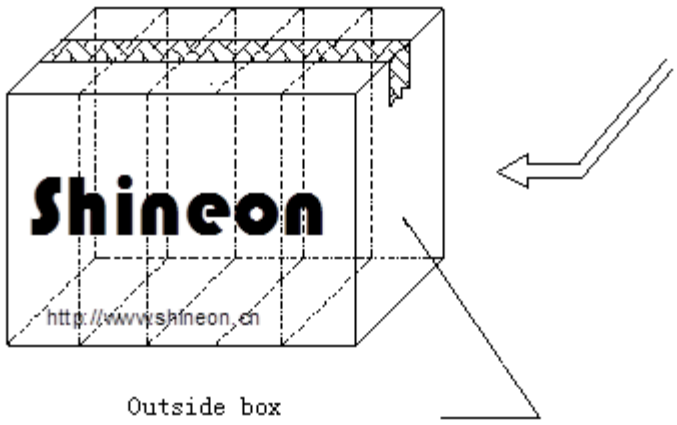
(2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be ±0.2mm

(3) Adhesion Strength of Cover Tape : Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at the angle of 10º to the carrier tape

(4) Package : P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof Package.

PACKAGING





Notes:
(1) Box size: 33x25x42cm 60K/Box 1500pcs/Reel
(2) Box size: 38x36x42cm 80K/Box 5000pcs/Reel,

Reliability Test Items

Test Items	Test Duration	Number of Damaged
Steady State Operating Life of High Temperature (HTOL) Ts=85℃, IF=Max	1000hrs	0/20
Steady State Operating Life of Low Temperature (LTOL) Ta=-40℃, IF=Max	1000hrs	0/20
High Temperature Storage (HTS) 100℃	1000hrs	0/20
Low Temperature Storage (LTS) -40℃	1000hrs	0/20
Thermal Shock (TS) -45℃~125℃ 15min dwell 30sec transfer	100cycles	0/20
Solder Resistance (SR) 265℃, 3X MSL	5sec	0/20
Solder Ability (SA) 245℃5sec, 95% coverage	5sec	0/11

Item	Symbol	Test Condition	Criteria for Judgment	
			Min.	Max.
Forward	Vf	IF=Typical Current		U.S.L x1.1
Luminous Flux	Im	IF=Typical Current	L.S.L x0.7	
CCX&CCY	x,y	IF=Typical Current		Shift<0.02

PRECAUTION FOR USE

(1) This device should not be used in any type of fluid such as water, oil, organic solvent, etc.
When washing is required, IPA should be used.

(2) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.

(3) LEDs must be stored to maintain a clean atmosphere. If the LEDs are stored for 3months or more after being shipped from ShineOn, a sealed container with a nitrogen atmosphere should be used for storage.

(4) The LEDs must be used within seven days after opening the moisture proof packing.
Repack unused Products with anti-moisture packing, fold to close any opening and then store in a dry place.

(5) The appearance and specifications of the product may be modified for improvement without notice.

(6) This LED is sensitive to the static electricity and surge. It is recommended to use a wrist Band or anti-electrostatic glove when handling the LEDs.

(7) On manual soldering, a solder tip must be needed as grounded for usage. If over voltage which exceeds the absolute maximum rating is applied to LEDs, it will cause damage LEDs and result in destruction. Damaged LEDs will show some unusual characteristics such as leak current remarkably increase ,turn-on voltage becomes lower and the LEDs get unlighted at low current.